WNSC2D021200MB



## Silicon Carbide Diode

Rev.01 - 16 August 2024

**Product data sheet** 

### **1. General description**

Silicon Carbide Schottky diode in a SMB plastic package, designed for high frequency switched-mode power supplies.



### 2. Features and benefits

- Highly stable switching performance
- High forward surge capability I<sub>FSM</sub>
- Extremely fast reverse recovery time
- Superior in efficiency to Silicon Diode alternatives
- Reduced losses in associated MOSFET
- Reduced EMI
- Reduced cooling requirements
- RoHS compliant
- High junction operating temperature capability (T<sub>j(max)</sub> = 175 °C)

### 3. Applications

- Gate driver boot-strap circuit
- Noise snubber
- Medical instruments
- LED / OLED drivers
- General power converters

### 4. Quick reference data

Table 1. Q	uick reference data						
Symbol	Parameter	Conditions	Notes	Values			Unit
Absolute	maximum rating						
$V_{\text{RRM}}$	repetitive peak reverse voltage				1200		V
I <sub>F</sub>	continuous forward current	T <sub>lead</sub> ≤ 100 °C, DC; <u>Fig. 2</u>			2		A
Tj	junction temperature			175		°C	
Symbol	Parameter	Conditions	Notes	Min Typ Max		Unit	
Static ch	aracteristics						
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 2 A; T <sub>j</sub> = 25 °C; <u>Fig. 5</u>		-	1.42	1.60	V
		I <sub>F</sub> = 2 A; T <sub>j</sub> = 150 °C; <u>Fig. 5</u>		-	1.90	2.30	V
Dynamic	characteristics	·					
Q <sub>r</sub>	recovered charge	$I_F = 2 \text{ A}; \text{ d}I_F/\text{d}t = 500 \text{ A}/\mu\text{s}; \text{ V}_R = 400 \text{ V};$ $T_j = 25 \text{ °C}; \text{ Fig. 7}$		-	4	-	nC

# 5. Pinning information

Table 2.	Table 2. Pinning information							
Pin	Symbol	Description	Simplified outline	Graphic symbol				
1	К	cathode						
2	A	anode		K <u> A</u> 001aaa020				

# 6. Ordering information

Table 3. Ordering information								
Type number	Package	Orderable part number		Small packing	Package	Package		
	name		method	quantity	version	issue date		
WNSC2D021200MB	SMB	WNSC2D021200MB6J	Reel	3000	SMB	20-Feb-2017		

# 7. Marking

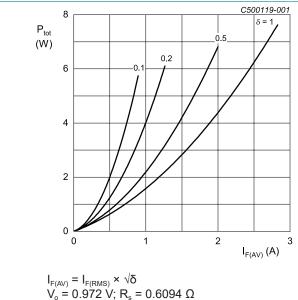
Table 4. Marking codes							
Type number	Marking codes						
WNSC2D021200MB	2212GE						

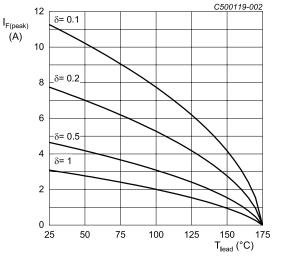
# 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Notes	Values	Unit
V <sub>RRM</sub>	repetitive peak reverse voltage			1200	V
V <sub>RWM</sub>	crest working reverse voltage			1200	V
V <sub>R</sub>	reverse voltage	DC		1200	V
l <sub>F</sub>	continuous forward	T <sub>lead</sub> ≤ 100 °C, DC; <u>Fig. 2</u>		2	А
	current	T <sub>lead</sub> ≤ 125 °C, DC; <u>Fig. 2</u>		1.5	А
		T <sub>lead</sub> ≤ 25 °C, DC; <u>Fig. 2</u>		3.1	А
I <sub>FRM</sub>	repetitive peak forward current	$\delta$ = 0.5; t <sub>p</sub> = 25 µs; T <sub>lead</sub> = 125 °C; square-wave pulse		2.4	A
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse		26	А
		$t_p$ = 10 µs; $T_{j(init)}$ = 25 °C; square-wave pulse		200	А
l <sup>2</sup> t	I <sup>2</sup> t for fusing	sine-wave pulse; $T_{j(init)}$ = 25 °C; $t_p$ = 10 ms		3.38	A <sup>2</sup> s
T <sub>stg</sub>	storage temperature			-55 to 175	°C
Tj	junction temperature			-55 to 175	°C



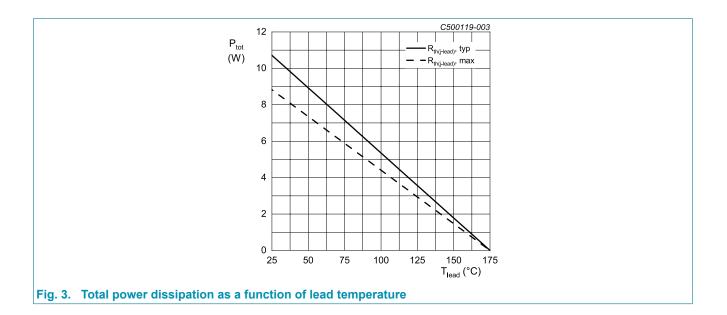




I<sub>F(AV)</sub> = I<sub>F(RMS)</sub> × √δ
V<sub>o</sub> = 0.972 V; R<sub>s</sub> = 0.6094 Ω
Fig. 1. Forward power dissipation as a function of average forward current; square waveform; maximum values

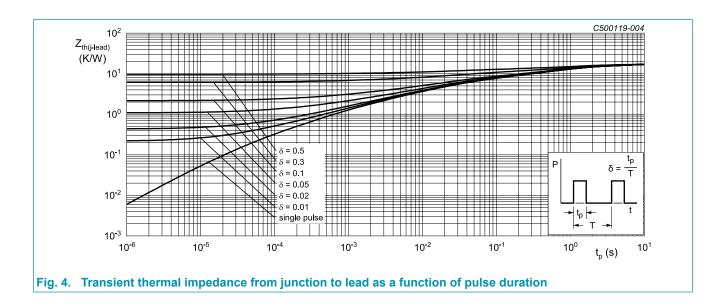
### **WeEn Semiconductors**

### WNSC2D021200MB Silicon Carbide Diode



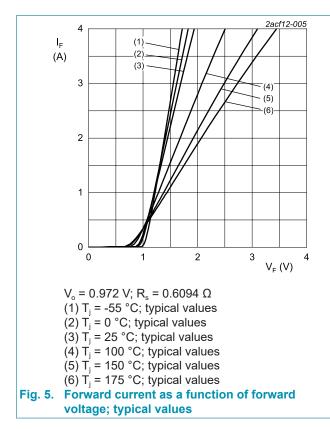
# 9. Thermal characteristics

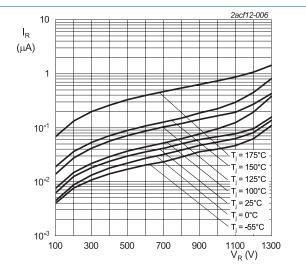
Table 6. Th	ermal characteristics						
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
$R_{\text{th(j-lead)}}$	thermal resistance from junction to lead			-	14	17	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air		-	90	-	K/W



## **10. Characteristics**

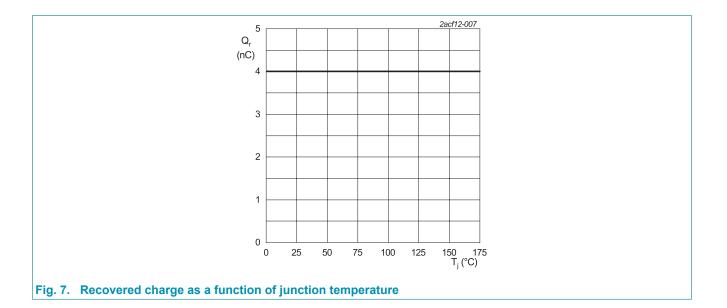
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
	aracteristics						
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 2 A; T <sub>j</sub> = 25 °C; <u>Fig. 5</u>		-	1.42	1.60	V
		I <sub>F</sub> = 2 A; T <sub>j</sub> = 150 °C; <u>Fig. 5</u>		-	1.90	2.30	V
		I <sub>F</sub> = 2 A; T <sub>j</sub> = 175 °C; <u>Fig. 5</u>		-	2.00	2.50	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 1200 V; T <sub>j</sub> = 25 °C; <u>Fig. 6</u>		-	0.5	10	μA
		V <sub>R</sub> = 1200 V; T <sub>j</sub> = 175 °C; <u>Fig. 6</u>		-	25	-	μA
Dynamic	characteristics						
Q <sub>r</sub>	recovered charge	$I_F = 2 \text{ A}; V_R = 400 \text{ V}; \text{ d}I_F/\text{d}t = 500 \text{ A}/\mu\text{s};$ $T_j = 25 \text{ °C}; Fig. 7$		-	4	-	nC
C <sub>d</sub>	diode capacitance	f = 1 MHz; V <sub>R</sub> = 1 V; T <sub>j</sub> = 25 °C		-	95	-	pF
		f = 1 MHz; V <sub>R</sub> = 400 V; T <sub>j</sub> = 25 °C		-	10	-	pF
		f = 1 MHz; V <sub>R</sub> = 800 V; T <sub>j</sub> = 25 °C		-	8	-	pF
E <sub>as</sub>	non-repetitive avalanche energy	$I_{R}$ = 2 A; L = 10 mH; $T_{j(init)}$ = 25 °C		18	-	-	mJ



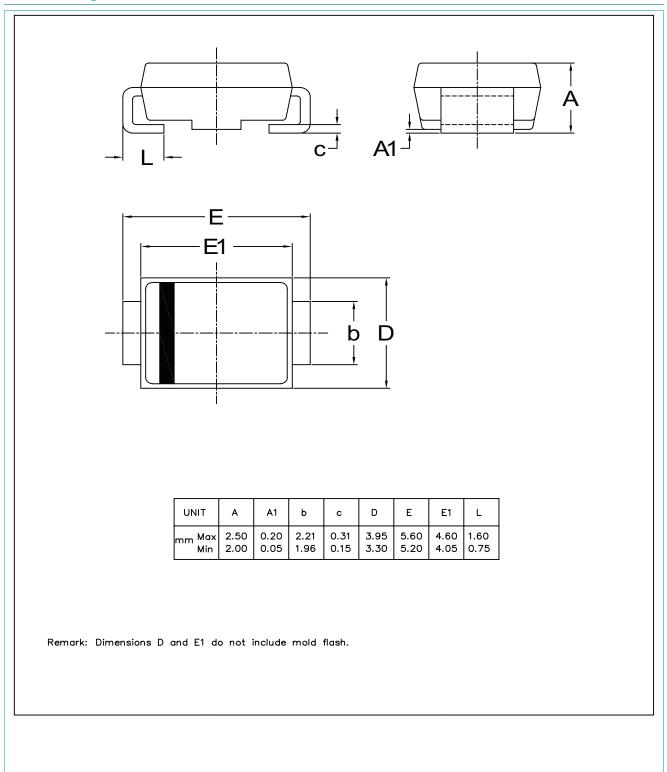




Silicon Carbide Diode



# **11. Package outline**



# WNSC2D021200MB

#### Silicon Carbide Diode

# 12. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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